



SURFACE MOUNT SCHOTTKY BARRIER DIODE

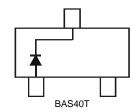
Features

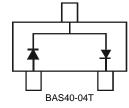
- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3, 4 and 5)

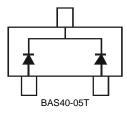
Mechanical Data

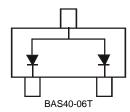
- Case: SOT-523
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagrams Below
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.002 grams (approximate)











Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	40	V
RMS Reverse Voltage		$V_{R(RMS)}$	28	V
Forward Continuous Current	(Note 1)	I _{FM}	200	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0s	I _{FSM}	600	mA

Thermal Characteristics

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Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 1)	P_{D}	150	mW
Thermal Resistance Junction to Ambient	(Note 1)	$R_{ hetaJA}$	833	°C/W
Operating Temperature Range		T_J	-55 to +125	°C
Storage Temperature Range		T _{STG}	-65 to +150	°C

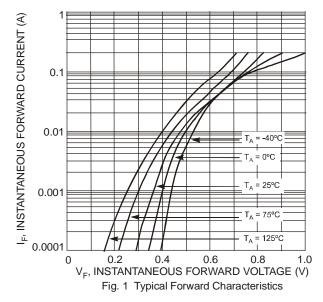
Electrical Characteristics @T_A = 25°C unless otherwise specified

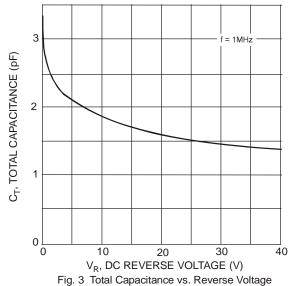
Characteristic		Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage	(Note 2)	V _{(BR)R}	40		V	$I_R = 10\mu A$
Forward Voltage		V _F	_	380 1000	mV mV	$I_F = 1.0 \text{mA}, t_p < 300 \mu \text{s}$ $I_F = 40 \text{mA}, t_p < 300 \mu \text{s}$
Leakage Current	(Note 2)	I _R	_	200	nA	$V_R = 30V$
Total Capacitance		Ст	_	5.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time		t _{rr}	_	5.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

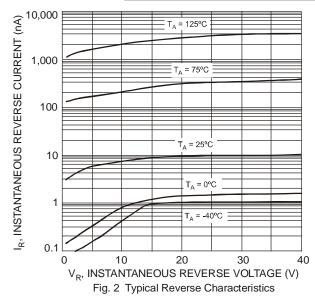
Notes:

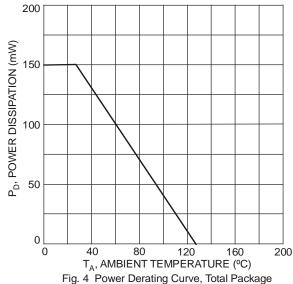
- 1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Short duration pulse test used to minimize self-heating effect.
- 3. No purposefully added lead. Halogen and Antimony Free.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 5. Product manufactured with Green Molding Compound and does not contain Halogens or Sb₂O₃ Fire Retardants.











2011

2012

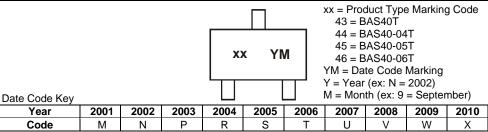
2013

Ordering Information (Note 6)

Part Number	Case	Packaging
BAS40T-7-F	SOT-523	3000/Tape & Reel
BAS40-04T-7-F	SOT-523	3000/Tape & Reel
BAS40-05T-7-F	SOT-523	3000/Tape & Reel
BAS40-06T-7-F	SOT-523	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



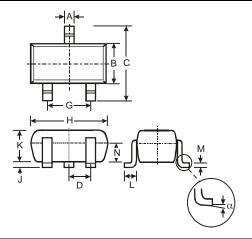
С В Month Jan Feb Mar Apr May Jun Jul Aug Sep Oct Nov Dec Code 4 5 6 8 9 0 Ν D

2015

2014

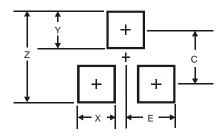


Package Outline Dimensions



SOT-523				
Dim	Min	Max	Тур	
Α	0.15	0.30	0.22	
В	0.75	0.85	0.80	
С	1.45	1.75	1.60	
D			0.50	
G	0.90	1.10	1.00	
Н	1.50	1.70	1.60	
J	0.00	0.10	0.05	
K	0.60	0.80	0.75	
L	0.10	0.30	0.22	
M	0.10	0.20	0.12	
N	0.45	0.65	0.50	
α	0°	8°	_	
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Υ	0.51
С	1.3
E	0.7

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